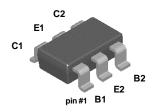


FFB3904

E2 B2 C1 SC70-6 B1 Mark: .1A pin#1 E1

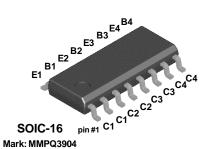
NOTE: The pinouts are symmetrical; pin 1 and pin 4 are interchangeable. Units inside the carrier can be of either orientation and will not affect the functionality of the device.

FMB3904



SuperSOTTM-6 Mark: .1A Dot denotes pin #1

MMPQ3904



NPN Multi-Chip General Purpose Amplifier

This device is designed as a general purpose amplifier and switch. The useful dynamic range extends to 100 mA as a switch and to 100 MHz as an amplifier. Sourced from Process 23.

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V_{CEO}	Collector-Emitter Voltage	40	V	
V _{CBO}	Collector-Base Voltage	60	V	
V _{EBO}	Emitter-Base Voltage	6.0	V	
I _C	Collector Current - Continuous	200	mA	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- 3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

Thermal Characteristics

 $T_A = 25$ °C unless otherwise noted

Symbol	Characteristic	Max			Units
		FFB3904	FMB3904	MMPQ3904	
P_D	Total Device Dissipation Derate above 25°C	300 2.4	700 5.6	1,000 8.0	mW mW/°C
R _θ JA	Thermal Resistance, Junction to Ambient Effective 4 Die Each Die	415	180	125 240	°C/W °C/W

(continued)

Electri		

 $\Gamma_{\Lambda} = 25^{\circ}$ C unless otherwise note

Parameter	Test Conditions	Min	Тур	Max	Units
RACTERISTICS					
Collector-Emitter Breakdown Voltage	$I_C = 1.0 \text{ mA}, I_B = 0$	40			V
Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	60			V
Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	6.0			V
Base Cutoff Current	$V_{CE} = 30 \text{ V}, V_{EB} = 0$			50	nA
Collector Cutoff Current	$V_{CE} = 30 \text{ V}, V_{EB} = 0$			50	nA
	RACTERISTICS Collector-Emitter Breakdown Voltage Collector-Base Breakdown Voltage Emitter-Base Breakdown Voltage Base Cutoff Current	RACTERISTICS Collector-Emitter Breakdown Voltage $I_C = 1.0 \text{ mA}, I_B = 0$ Collector-Base Breakdown Voltage $I_C = 10 \mu\text{A}, I_E = 0$ Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ Base Cutoff Current $V_{CE} = 30 \text{ V}, V_{EB} = 0$	RACTERISTICS Collector-Emitter Breakdown Voltage $I_C = 1.0 \text{ mA}, I_B = 0$ 40 Collector-Base Breakdown Voltage $I_C = 10 \mu\text{A}, I_C = 0$ 60 Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ 6.0 Base Cutoff Current $V_{CE} = 30 \text{ V}, V_{EB} = 0$	RACTERISTICS Collector-Emitter Breakdown Voltage $I_C = 1.0 \text{ mA}, I_B = 0$ 40 Collector-Base Breakdown Voltage $I_C = 10 \mu\text{A}, I_C = 0$ 60 Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ 6.0 Base Cutoff Current $V_{CE} = 30 \text{ V}, V_{EB} = 0$	RACTERISTICS Collector-Emitter Breakdown Voltage $I_C = 1.0 \text{ mA}, I_B = 0$ 40 Collector-Base Breakdown Voltage $I_C = 10 \mu A, I_C = 0$ 60 Emitter-Base Breakdown Voltage $I_E = 10 \mu A, I_C = 0$ 6.0 Base Cutoff Current $V_{CE} = 30 \text{ V}, V_{EB} = 0$ 50

ON CHARACTERISTICS*

h _{FE}	DC Current Gain	$I_C = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$	40		
		MMPQ3904	30		
		$I_C = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$	70		
		MMPQ3904	50		
		$I_C = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$	100	300	
		MMPQ3904	75		
		$I_C = 50 \text{ mA}, V_{CE} = 1.0 \text{ V}$	60		
		$I_C = 100 \text{ mA}, V_{CE} = 1.0 \text{ V}$	30		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$		0.2	V
		$I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$		0.3	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$	0.65	0.85	V
		$I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$		0.95	V

SMALL SIGNAL CHARACTERISTICS (MMPQ3904 only)

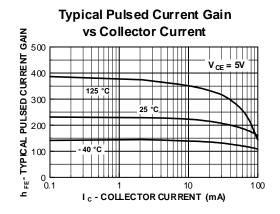
f _T	Current Gain - Bandwidth Product	$I_C = 10 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz	250	MHz
C _{obo}	Output Capacitance	$V_{CB} = 5.0 \text{ V}, I_{E} = 0,$ f = 140 kHz	4.0	pF
C _{ibo}	Input Capacitance	$V_{EB} = 0.5 \text{ V}, I_{C} = 0,$ f = 140 kHz	8.0	pF

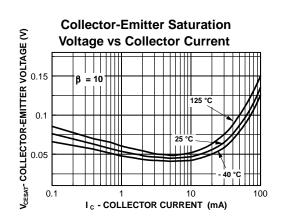
^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

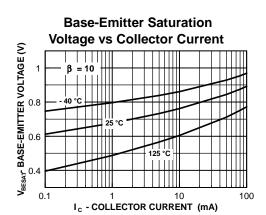
NOTE: All voltages (V) and currents (A) are negative polarity for PNP transistors.

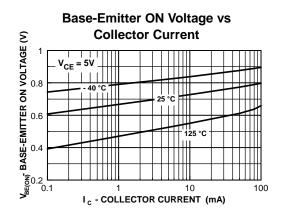
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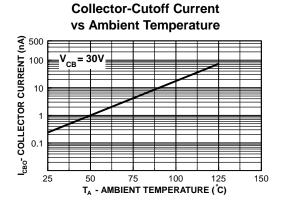
Typical Characteristics

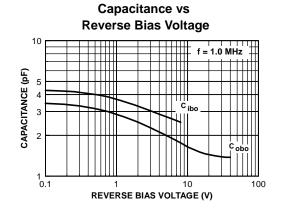








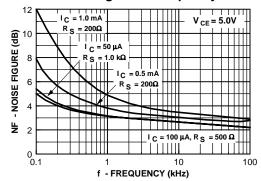




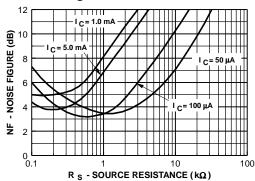
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Typical Characteristics (continued)

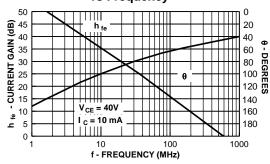




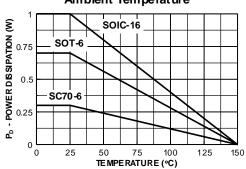
Noise Figure vs Source Resistance



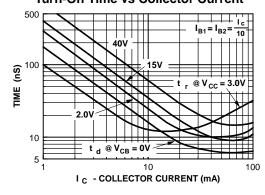
Current Gain and Phase Angle vs Frequency



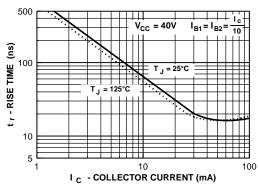
Power Dissipation vs Ambient Temperature



Turn-On Time vs Collector Current



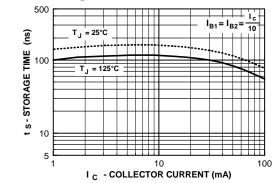
Rise Time vs Collector Current



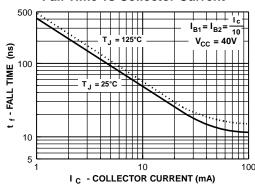
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Typical Characteristics (continued)

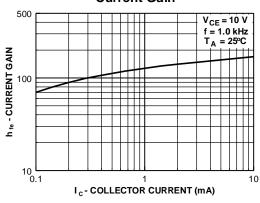




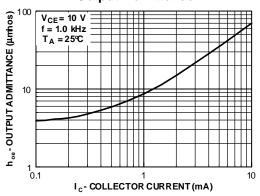
Fall Time vs Collector Current



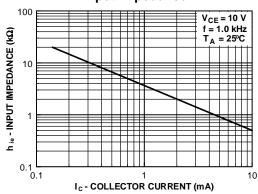
Current Gain



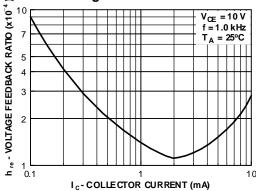
Output Admittance



Input Impedance



Voltage Feedback Ratio



(continued)

Test Circuits

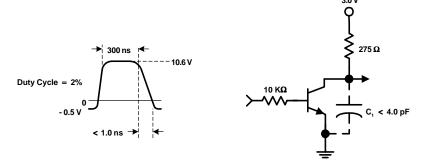


FIGURE 1: Delay and Rise Time Equivalent Test Circuit

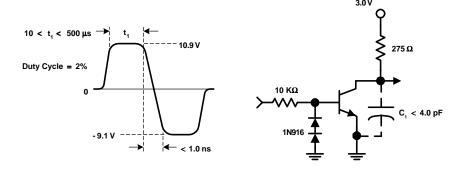


FIGURE 2: Storage and Fall Time Equivalent Test Circuit

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